

Special Issue

Recent Trends in Nanofluids

Message from the Guest Editors

This Special Issue invites you to contribute your original research work and review articles on “Nanofluids”, which are either advances of state-of-the-art mathematical methods, theoretical or experimental studies or which extend the bounds of existing methodologies to new contributions to address current challenges. We hope that this issue will provide up-to-date findings to the readers and scientific community for application to the benefit of the industrial sector. Potential topics include but are not limited to:

- Nanofluids
- Particle shape effects
- Convective heat and mass transfer
- Steady and unsteady flow problems
- Multiphase flow simulations
- Thermodynamics
- Physiological fluid phenomena in biological systems
- Numerical and analytical simulations

Guest Editors

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The unique journal *Inventions* is different from all other journals. Many scholars spend their lives publishing research papers in many different journals, but most of these journals do not help scholars collate and analyze their results or assist in promoting them to a relevant industry. However, *Inventions* will help authors not only to publish their papers in the journal, but also to promote their research results to industry and assist them in realizing the purpose of technology transfer. In the future, *Inventions* will help authors to evaluate their technology license fees based on the valuation theory and approaches and also help authors to show their patents and technologies on a network transaction platform.

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